

What Is Claimed Is:

- 1 1. A method to facilitate auto-alignment of images for defect
2 inspection and defect analysis, comprising:
3 receiving a reference image and a test image;
4 creating a horizontal cut line across the reference image;
5 choosing a vertical feature on the reference image with a specified width
6 along the horizontal cut line;
7 determining that the vertical feature substantially maintains the specified
8 width over a specified range above and below the horizontal cut line;
9 locating a corresponding vertical feature on the test image;
10 creating a vertical cut line across the reference image;
11 choosing a horizontal feature on the reference image with the specified
12 width along the vertical cut line;
13 determining that the horizontal feature substantially maintains the
14 specified width over a specified range left and right of the vertical cut line;
15 locating a corresponding horizontal feature on the test image; and
16 aligning the reference image and the test image by aligning the vertical
17 feature on the reference image with the corresponding vertical feature on the test
18 image and aligning the horizontal feature on the reference image with the
19 corresponding horizontal feature on the test image.
- 1 2. The method of claim 1, further comprising:
2 creating a first plurality of horizontal cut lines across the reference image;
3 choosing the horizontal cut line including at least one vertical feature from
4 the first plurality of horizontal cut lines;
5 creating a first plurality of vertical cut lines across the reference image;

6 choosing the vertical cut line including at least one horizontal feature from
7 the first plurality of vertical cut lines;
8 creating a second plurality of horizontal cut lines across the test image;
9 choosing a test horizontal cut line from the second plurality of horizontal
10 cut lines, by iterating through the second plurality of horizontal cut lines until the
11 test horizontal cut line includes a test vertical feature with a substantially same
12 horizontal width and same neighborhood characteristics as the vertical feature;
13 creating a second plurality of vertical cut lines across the test image;
14 choosing a test vertical cut line from the second plurality of vertical cut
15 lines, by iterating through the second plurality of vertical cut lines until the test
16 vertical cut line includes a test horizontal feature with a substantially same vertical
17 width and same neighborhood characteristics as the horizontal feature;
18 aligning the reference image and the test image in a horizontal direction
19 using the horizontal cut line and the test horizontal cut line; and
20 aligning the reference image and the test image in a vertical direction using
21 the vertical cut line and the test vertical cut line.

1 3. The method of claim 2, further comprising aligning the reference
2 image and the test image using edges of the vertical feature and the horizontal
3 feature.

1 4. The method of claim 2, further comprising aligning the reference
2 image and the test image using midpoints of the vertical feature and the horizontal
3 feature.

1 5. The method of claim 1, wherein the reference image includes one
2 of:

3 an inspection mask generated by mask inspection equipment;
 4 a mask image from a database;
 5 a wafer image; and
 6 a die image.

1 6. The method of claim 1, wherein the test image includes one of:
 2 an inspection mask generated by mask inspection equipment;
 3 a mask image from a database;
 4 a wafer image; and
 5 a die image.

1 7. The method of claim 1, further comprising:
 2 clustering feature widths within the reference image; and
 3 choosing a width that occurs most often as the specified width.

1 8. A computer-readable storage medium storing instructions that
 2 when executed by a computer cause the computer to perform a method to
 3 facilitate auto-alignment of images for defect inspection and defect analysis, the
 4 method comprising:
 5 receiving a reference image and a test image;
 6 creating a horizontal cut line across the reference image;
 7 choosing a vertical feature on the reference image with a specified width
 8 along the horizontal cut line;
 9 determining that the vertical feature substantially maintains the specified
 10 width over a specified range above and below the horizontal cut line;
 11 locating a corresponding vertical feature on the test image;
 12 creating a vertical cut line across the reference image;

13 choosing a horizontal feature on the reference image with the specified
14 width along the vertical cut line;
15 determining that the horizontal feature substantially maintains the
16 specified width over a specified range left and right of the vertical cut line;
17 locating a corresponding horizontal feature on the test image; and
18 aligning the reference image and the test image by aligning the vertical
19 feature on the reference image with the corresponding vertical feature on the test
20 image and aligning the horizontal feature on the reference image with the
21 corresponding horizontal feature on the test image.

1 9. The computer-readable storage medium of claim 8, the method
2 further comprising:
3 creating a first plurality of horizontal cut lines across the reference image;
4 choosing the horizontal cut line including at least one vertical feature from
5 the first plurality of horizontal cut lines;
6 creating a first plurality of vertical cut lines across the reference image;
7 choosing the vertical cut line including at least one horizontal feature from
8 the first plurality of vertical cut lines;
9 creating a second plurality of horizontal cut lines across the test image;
10 choosing a test horizontal cut line from the second plurality of horizontal
11 cut lines, by iterating through the second plurality of horizontal cut lines until the
12 test horizontal cut line includes a test vertical feature with a substantially same
13 horizontal width and same neighborhood characteristics as the vertical feature;
14 creating a second plurality of vertical cut lines across the test image;
15 choosing a test vertical cut line from the second plurality of vertical cut
16 lines, by iterating through the second plurality of vertical cut lines until the test

17 vertical cut line includes a test horizontal feature with a substantially same vertical
18 width and same neighborhood characteristics as the horizontal feature;
19 aligning the reference image and the test image in a horizontal direction
20 using the horizontal cut line and the test horizontal cut line; and
21 aligning the reference image and the test image in a vertical direction using
22 the vertical cut line and the test vertical cut line.

1 10. The computer-readable storage medium of claim 9, the method
2 further comprising aligning the reference image and the test image using edges of
3 the vertical feature and the horizontal feature.

1 11. The computer-readable storage medium of claim 9, the method
2 further comprising aligning the reference image and the test image using
3 midpoints of the vertical feature and the horizontal feature.

1 12. The computer-readable storage medium of claim 8, wherein the
2 reference image includes one of:
3 an inspection mask generated by mask inspection equipment;
4 a mask image from a database;
5 a wafer image; and
6 a die image.

1 13. The computer-readable storage medium of claim 8, wherein the
2 test image includes one of:
3 an inspection mask generated by mask inspection equipment;
4 a mask image from a database;
5 a wafer image; and

6 a die image.

1 14. The computer-readable storage medium of claim 8, the method
2 further comprising:
3 clustering feature widths within the reference image; and
4 choosing a width that occurs most often as the specified width.

1 15. An apparatus to facilitate auto-alignment of images for defect
2 inspection and defect analysis, comprising:
3 a receiving mechanism that is configured to receive a reference image and
4 a test image;
5 a creating mechanism that is configured to create a horizontal cut line
6 across the reference image;
7 wherein the creating mechanism is further configured to create a vertical
8 cut line across the reference image;
9 a choosing mechanism that is configured to choose a vertical feature on
10 the reference image with a specified width along the horizontal cut line;
11 wherein the choosing mechanism is further configured to choose a
12 horizontal feature on the reference image with the specified width along the
13 vertical cut line;
14 a determining mechanism that is configured to determine that the vertical
15 feature substantially maintains the specified width over a specified range above
16 and below the horizontal cut line;
17 wherein the determining mechanism is further configured to determine
18 that the horizontal feature substantially maintains the specified width over a
19 specified range left and right of the vertical cut line;

20 a locating mechanism that is configured to locate a corresponding vertical
 21 feature on the test image;
 22 wherein the locating mechanism is further configured to locate a
 23 corresponding horizontal feature on the test image; and
 24 an aligning mechanism that is configured to align the reference image and
 25 the test image by aligning the vertical feature on the reference image and the
 26 corresponding vertical feature on the test image and by aligning the horizontal
 27 feature on the reference image and the corresponding horizontal feature on the test
 28 image.

1 16. The apparatus of claim 15, wherein
 2 the creating mechanism is further configured to create a first plurality of
 3 horizontal cut lines across the reference image;
 4 the choosing mechanism is further configured to choose the horizontal cut
 5 line including at least one vertical feature from the first plurality of horizontal cut
 6 lines;
 7 the creating mechanism is further configured to create a first plurality of
 8 vertical cut lines across the reference image;
 9 the choosing mechanism is further configured to choose the vertical cut
 10 line including at least one horizontal feature from the first plurality of vertical cut
 11 lines;
 12 the creating mechanism is further configured to create a second plurality of
 13 horizontal cut lines across the test image;
 14 the choosing mechanism is further configured to choose a test horizontal
 15 cut line from the second plurality of horizontal cut lines, by iterating through the
 16 second plurality of horizontal cut lines until the test horizontal cut line includes a

17 test vertical feature with a substantially same horizontal width and same
18 neighborhood characteristics as the vertical feature;
19 the creating mechanism is further configured to create a second plurality of
20 vertical cut lines across the test image;
21 the choosing mechanism is further configured to choose a test vertical cut
22 line from the second plurality of vertical cut lines, by iterating through the second
23 plurality of vertical cut lines until the test vertical cut line includes a test
24 horizontal feature with a substantially same vertical width and same neighborhood
25 characteristics as the horizontal feature;
26 the aligning mechanism is further configured to align the reference image
27 and the test image in a horizontal direction using the horizontal cut line and the
28 test horizontal cut line; and
29 the aligning mechanism is further configured to align the reference image
30 and the test image in a vertical direction using the vertical cut line and the test
31 vertical cut line.

1 17. The apparatus of claim 16, wherein the aligning mechanism is
2 further configured to align the reference image and the test image using edges of
3 the vertical feature and the horizontal feature.

1 18. The apparatus of claim 16, wherein the aligning mechanism is
2 further configured to align the reference image and the test image using midpoints
3 of the vertical feature and the horizontal feature.

1 19. The apparatus of claim 15, wherein the reference image includes
2 one of:
3 an inspection mask generated by mask inspection equipment;

4 a mask image from a database;
5 a wafer image; and
6 a die image.

1 20. The apparatus of claim 15, wherein the test image includes one of:
2 an inspection mask generated by mask inspection equipment;
3 a mask image from a database;
4 a wafer image; and
5 a die image.

1 21. The apparatus of claim 15, further comprising:
2 a clustering mechanism that is configured to cluster feature widths within
3 the reference image; and
4 wherein the choosing mechanism is further configured to choose a width
5 that occurs most often as the specified width.

1 22. A system to facilitate auto-alignment of images for defect
2 inspection and defect analysis, comprising:
3 receiving means for receiving a reference image and a test image;
4 creating means for creating a horizontal cut line across the reference
5 image;
6 choosing means for choosing a vertical feature on the reference image with
7 a specified width along the horizontal cut line;
8 determining means for determining that the vertical feature substantially
9 maintains the specified width over a specified range above and below the
10 horizontal cut line;

11 locating means for locating a corresponding vertical feature on the test
12 image;
13 creating means for creating a vertical cut line across the reference image;
14 choosing means for choosing a horizontal feature on the reference image
15 with the specified width along the vertical cut line;
16 determining means for determining that the horizontal feature substantially
17 maintains the specified width over a specified range left and right of the vertical
18 cut line;
19 locating means for locating a corresponding horizontal feature on the test
20 image; and
21 aligning means for aligning the reference image and the test image by
22 aligning the vertical feature on the reference image to the corresponding vertical
23 feature on the test image and by aligning the horizontal feature on the reference
24 image and the corresponding horizontal feature on the test image.

23. The system of claim 22, further comprising:

- creating means for creating a first plurality of horizontal cut lines across the reference image;
- choosing means for choosing the horizontal cut line including at least one vertical feature from the first plurality of horizontal cut lines;
- creating means for creating a first plurality of vertical cut lines across the reference image;
- choosing means for choosing the vertical cut line including at least one horizontal feature from the first plurality of vertical cut lines;
- creating means for creating a second plurality of horizontal cut lines across the test image;

12 choosing means for choosing a test horizontal cut line from the second
 13 plurality of horizontal cut lines, by iterating through the second plurality of
 14 horizontal cut lines until the test horizontal cut line includes a test vertical feature
 15 with a substantially same horizontal width as the vertical feature and a
 16 substantially same neighboring characteristics on the test vertical feature as
 17 determined by width;

18 creating means for creating a second plurality of vertical cut lines across
 19 the test image;

20 choosing means for choosing a test vertical cut line from the second
 21 plurality of vertical cut lines, by iterating through the second plurality of vertical
 22 cut lines until the test vertical cut line includes a test horizontal feature with a
 23 substantially same vertical width as the horizontal feature and a substantially same
 24 neighboring characteristics on the test horizontal feature as determined by width;

25 aligning means for aligning the reference image and the test image in a
 26 horizontal direction using the horizontal cut line and the test horizontal cut line;
 27 and

28 aligning means for aligning the reference image and the test image in a
 29 vertical direction using the vertical cut line and the test vertical cut line.

1 24. The system of claim 23, further comprising aligning means for
 2 aligning the reference image and the test image using edges of the vertical feature
 3 and the horizontal feature.

1 25. The system of claim 23, further comprising aligning means for
 2 aligning the reference image and the test image using midpoints of the vertical
 3 feature and the horizontal feature.

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1 26. The system of claim 22, wherein the reference image includes one
2 of:
3 an inspection mask generated by mask inspection equipment;
4 a mask image from a database;
5 a wafer image; and
6 a die image.

1 27. The system of claim 22, wherein the test image includes one of:
2 an inspection mask generated by mask inspection equipment;
3 a mask image from a database;
4 a wafer image; and
5 a die image.

1 28. The system of claim 22, further comprising:
2 clustering means for clustering feature widths within the reference image;
3 and
4 choosing means for choosing a width that occurs most often as the
5 specified width.